

62mm Half Bridge IGBT Module

DESCRIPTION :

- 1200V Trench / Field Stop Technology
- Low Switching Power Loss
- Positive Temperature Coefficient

TYPICAL APPLICATIONS :

- Variable-frequency Drive
- Servo
- UPS
- Inverter



$V_{CES} = 1200V$, $I_{C\ nom} = 200A$ / $I_{CRM} = 400A$

IGBT, Inverter

MAXIMUM RATINGS

Characteristic	Condition	Symbol	Value	Unit
Collector- Emitter Voltage	$T_{vj}=25^{\circ}C$	V_{CES}	1200	V
Continuous DC collector current	$T_c=100^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	$I_{C\ nom}$	200	A
Repetitive peak collector current	$t_p=1ms$	I_{CRM}	400	A
Total power dissipation	$T_c=25^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	P_{tot}	1100	W
Gate emitter voltage		V_{GE}	± 20	V

ELECTRICAL CHARATERISTICS

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Collector-Emitter saturation voltage $V_{GE}=15V$, $I_C=200A$ $T_{vj}=25^{\circ}C$ $V_{GE}=15V$, $I_C=200A$ $T_{vj}=125^{\circ}C$ $V_{GE}=15V$, $I_C=200A$ $T_{vj}=150^{\circ}C$	$V_{CE(SAT)}$		1.84 2.10 2.15	2.20	V
Gate-Emitter threshold voltage $I_C=7.6mA$, $V_{GE}= V_{CE}$ $T_{vj}=25^{\circ}C$	$V_{GE(th)}$	5.3	5.9	6.5	V
Gate charge $V_{GE} = -15 V \dots +15 V$	Q_G		1.58		μC
Internal gate resistor ($T_{vj} = 25^{\circ}C$)	R_{Gint}		3.65		Ω
Input capacitance $f=1\ MHz$, $V_{CE}=25V$, $V_{GE}=0V$ $T_{vj}=25^{\circ}C$	C_{ies}		17.33		nF

M200R12E6F

Reverse transfer capacitance $f=1\text{ MHz}$, $V_{CE}=25\text{ V}$, $V_{GE}=0\text{ V}$ $T_{vj}=25^{\circ}\text{C}$	C_{res}		0.70		nF
Collector-emitter cut-off current $V_{CE}=1200\text{ V}$, $V_{GE}=0\text{ V}$ $T_{vj}=25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current $V_{CE}=0\text{ V}$, $V_{GE}=20\text{ V}$ $T_{vj}=25^{\circ}\text{C}$	I_{GES}			200	nA
Turn-on delay time $I_C=200\text{ A}$, $V_{CE}=600\text{ V}$ $T_{vj}=25^{\circ}\text{C}$ $V_{GE}=\pm 15\text{ V}$, $R_G=2.5\Omega$ $T_{vj}=125^{\circ}\text{C}$ (inductive load) $T_{vj}=150^{\circ}\text{C}$	$t_{d(ON)}$		211 227 225		ns
Rise time $I_C=200\text{ A}$, $V_{CE}=600\text{ V}$ $T_{vj}=25^{\circ}\text{C}$ $V_{GE}=\pm 15\text{ V}$, $R_G=2.5\Omega$ $T_{vj}=125^{\circ}\text{C}$ (inductive load) $T_{vj}=150^{\circ}\text{C}$	t_r		102 104 112		ns
Turn-off delay time $I_C=200\text{ A}$, $V_{CE}=600\text{ V}$ $T_{vj}=25^{\circ}\text{C}$ $V_{GE}=\pm 15\text{ V}$, $R_G=2.5\Omega$ $T_{vj}=125^{\circ}\text{C}$ (inductive load) $T_{vj}=150^{\circ}\text{C}$	$t_{d(OFF)}$		361 417 433		ns
Fall time $I_C=200\text{ A}$, $V_{CE}=600\text{ V}$ $T_{vj}=25^{\circ}\text{C}$ $V_{GE}=\pm 15\text{ V}$, $R_G=2.5\Omega$ $T_{vj}=125^{\circ}\text{C}$ (inductive load) $T_{vj}=150^{\circ}\text{C}$	t_f		99 134 185		ns
Turn-on energy loss per pulse $I_C=200\text{ A}$, $V_{CE}=600\text{ V}$ $T_{vj}=25^{\circ}\text{C}$ $V_{GE}=\pm 15\text{ V}$, $R_G=2.5\Omega$ $T_{vj}=125^{\circ}\text{C}$ (inductive load) $T_{vj}=150^{\circ}\text{C}$	$E_{(ON)}$		19.97 26.44 27.89		mJ
Turn-off energy loss per pulse $I_C=200\text{ A}$, $V_{CE}=600\text{ V}$ $T_{vj}=25^{\circ}\text{C}$ $V_{GE}=\pm 15\text{ V}$, $R_G=2.5\Omega$ $T_{vj}=125^{\circ}\text{C}$ (inductive load) $T_{vj}=150^{\circ}\text{C}$	$E_{(OFF)}$		13.08 17.99 18.75		mJ
Short circuit (SC) data $V_{GE} \leq 15\text{ V}$, $V_{CE}=800\text{ V}$ $V_{CEmax}=V_{CES}-L_{sCE} \cdot di/dt$ $t_p \leq 10\mu s$, $T_{vj}=150^{\circ}\text{C}$	I_{SC}		1264		A
Thermal resistance, junction to case (per IGBT)	R_{thJC}			0.14	K/W
Temperature under switching conditions	$T_{vj\text{ op}}$	-40		150	$^{\circ}\text{C}$

Diode, Inverter

MAXIMUM RATINGS

Characteristic	Condition	Symbol	Value	Unit
Repetitive peak reverse voltage	$T_{vj}=25^{\circ}\text{C}$	V_{RRM}	1200	V
Continuous DC forward current		I_F	200	A
Repetitive peak forward current	$t_p=1\text{ms}$	I_{FRM}	400	A
I^2t -value	$t_p=10\text{ms}$, $\sin 180^{\circ}$, $T_{vj}=125^{\circ}\text{C}$	I^2t	1479	A^2s

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Forward voltage IF=200A, VGE=0 V Tvj=25°C IF=200A, VGE=0 V Tvj=125°C IF=200A, VGE=0 V Tvj=150°C	V _F		2.42 2.55 2.43	2.90	V
Peak reverse recovery current IF=200 A, -diF/dt =1742A/μs(Tvj=150°C) VR=600 V ,VGE= -15 V Tvj=25°C Tvj=125°C Tvj=150°C	I _{RM}		90 115 128		A
Recovered charge IF=200 A, -diF/dt =1742A/μs(Tvj=150°C) VR=600 V ,VGE= -15 V Tvj=25°C Tvj=125°C Tvj=150°C	Q _r		9.19 19.91 24.39		uC
Reverse recovered energy IF=200 A, -diF/dt =1742A/μs(Tvj=150°C) VR=600 V ,VGE= -15 V Tvj=25°C Tvj=125°C Tvj=150°C	E _{rec}		3.15 7.56 9.32		mJ
Thermal resistance, junction to case (per diode)	R _{thJC}			0.2	K/W
Temperature under switching conditions	Tvj op	-40		150	°C

Module

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Isolation test voltage RMS, f=50Hz, t=1min	V _{ISOL}	4000			V
Internal isolation		Al ₂ O ₃			

Storage temperature	T_{STG}	-40		125	°C
Mounting torque for modul mounting	M	3		6	Nm
Weight	W		324		g

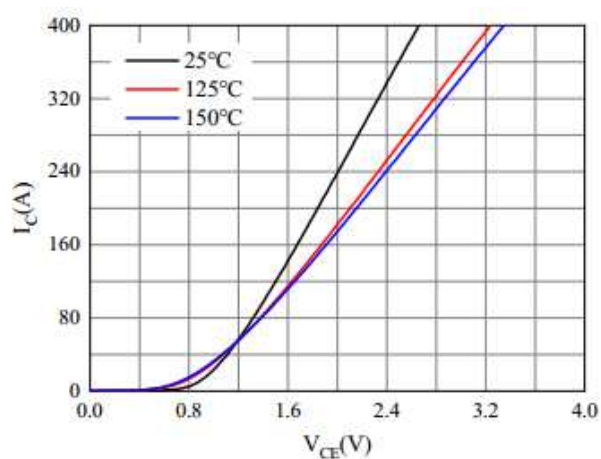


Figure 1. Typical output characteristics ($V_{GE}=15V$)

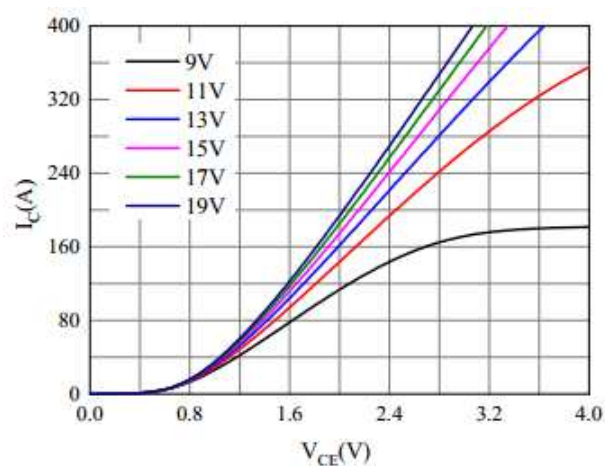


Figure 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

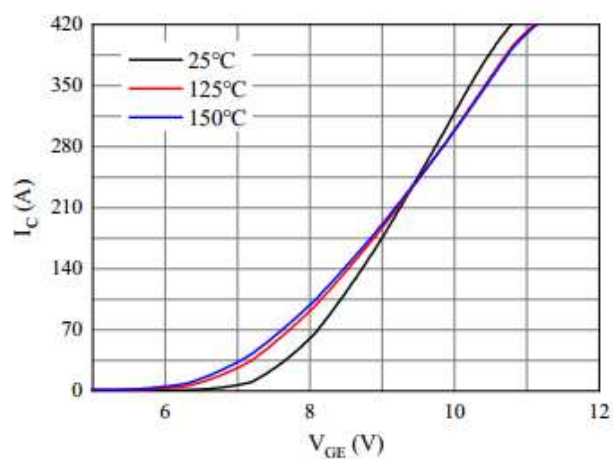


Figure 3. Typical transfer characteristic ($V_{CE}=20V$)

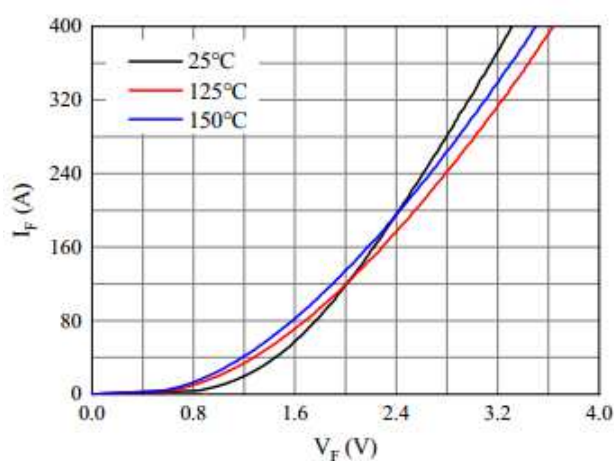


Figure 4. Forward characteristic of Diode

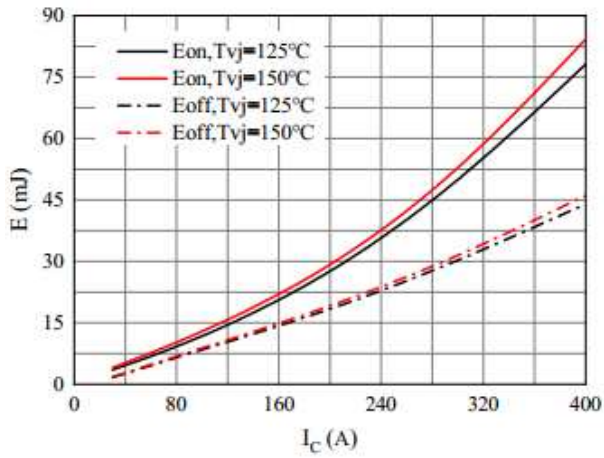


Figure 5. Switching losses of IGBT
VGE=± 15V, RGon=2.5Ω, RGoff=2.5Ω, VCE=600V

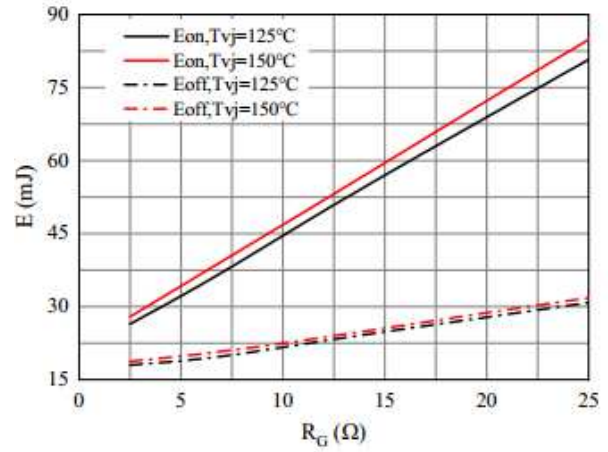


Figure 6. Switching losses of IGBT
VGE=± 15V, IC=200A, VCE=600V

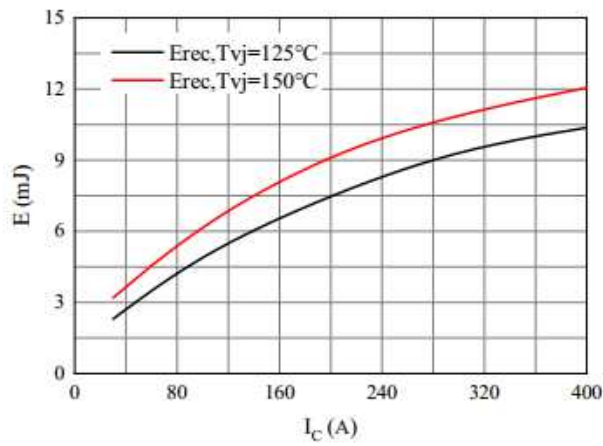


Figure 7. Switching losses of Diode
RGon=2.5Ω, VCE=600V

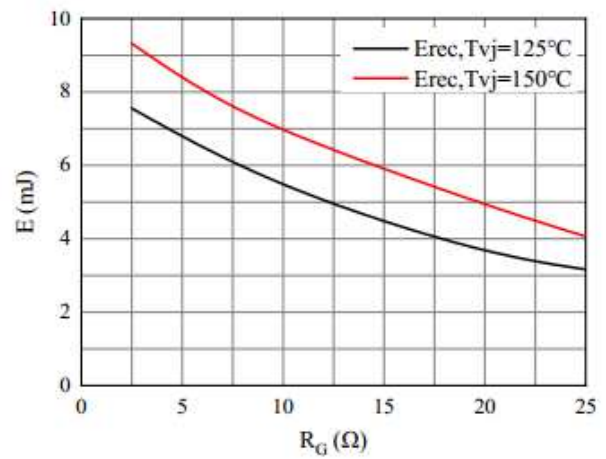


Figure 8. Switching losses of Diode
IF=200A, VCE=600V

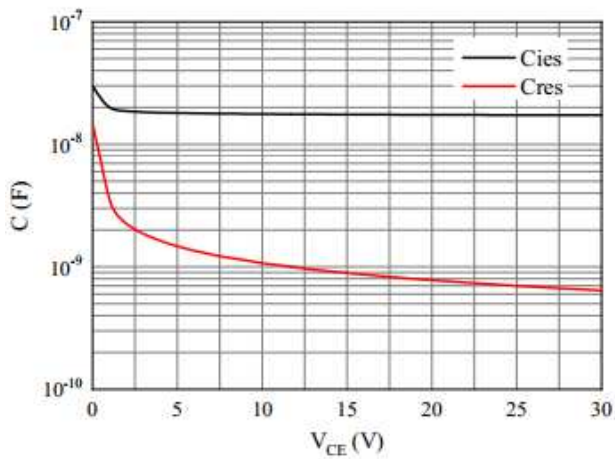
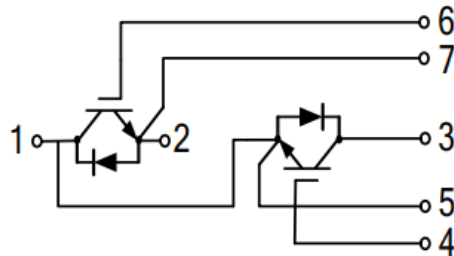
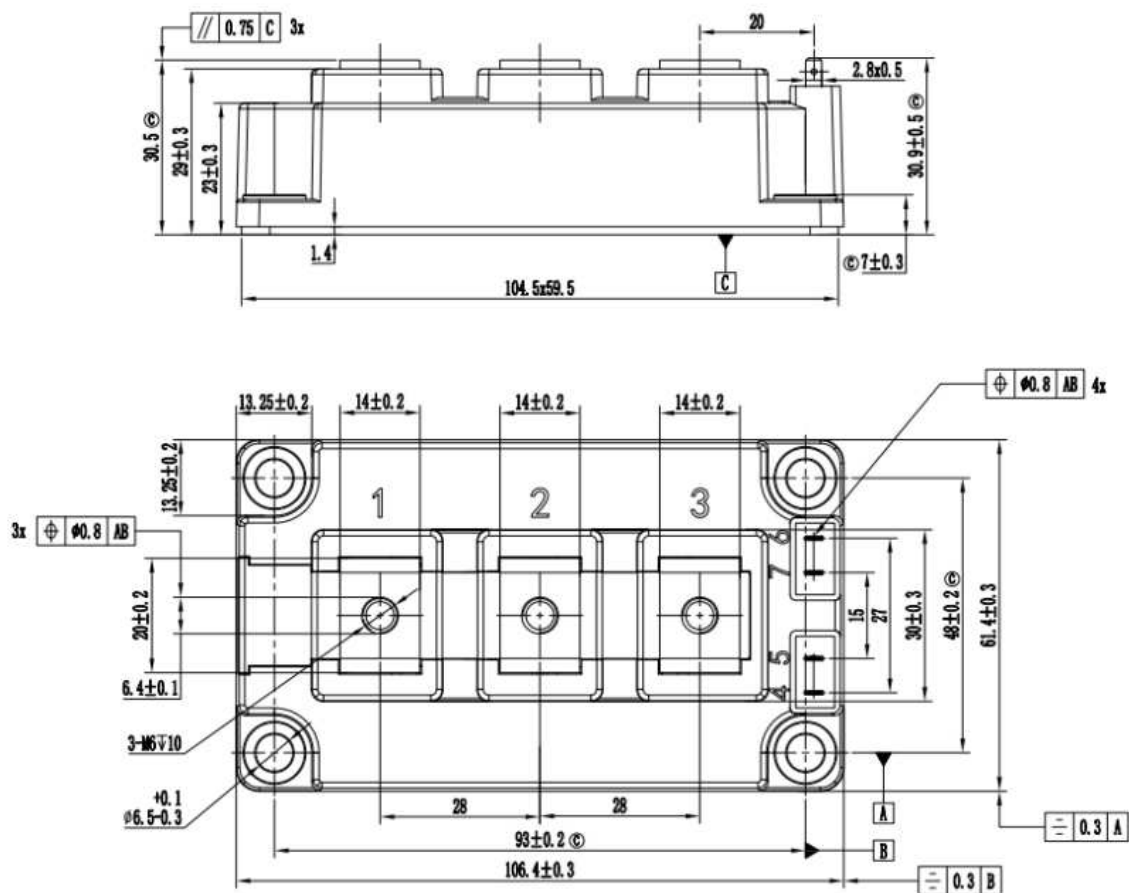


Figure 9. Capacitance characteristic

- Circuit diagram



- Package outlines : Dimensions in (mm)



Remark: 1. © control key dimensions

2. Unmarked tolerances shall be implemented in accordance with GB/T1804-m

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